

FDPF44N25T N-Channel UniFETTM MOSFET 250 V, 44 A, 69 mΩ

Features

- $R_{DS(on)}$ = 69 m Ω (Max.) @ V_{GS} = 10 V, I_D = 22 A
- Low Gate Charge (Typ. 47 nC)
- Low C_{rss} (Typ. 60 pF)

Applications

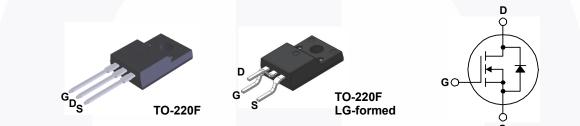
- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply



FDPF44N25T — N-Channel UniFETTM MOSFET

Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter	FDPF44N25T FDPF44N25TRDTU	Unit
V _{DSS}	Drain-Source Voltage		250	V
ID	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	44* 26.4*	A A
I _{DM}	Drain Current	- Pulsed (Note 1)	176*	Α
V _{GSS}	Gate-Source voltage		± 30	V
E _{AS}	Single Pulsed Avalance	che Energy (Note 2)	2055	mJ
I _{AR}	Avalanche Current	(Note 1)	44	А
E _{AR}	Repetitive Avalanche	Energy (Note 1)	30.7	mJ
dv/dt	Peak Diode Recovery	dv/d (Note 3)	4.5	V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate Above 25°C	38 0.3	W W/°C
T _{J,} T _{STG}	Operating and Storag	e Temperature Range	-55 to +150	°C
TL	Maximum Lead Tempe	erature for Soldering, 1/8" from Case for 5 Seconds	300	°C

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FDPF44N25T FDPF44N25TRDTU	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	3.3	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	0/11	

N-Channel UniFET TM MOS	FDPF44N25T
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Part N	umber	Top Mark	Package	Packing Method	Reel Size	Ta	ape Width	Qu	antity	
FDPF4			TO-220F			N/A		50	50 units	
FDPF44N	25TRDTU	FDPF44N25T	TO-220F (LG-formed)	Tube	N/A		N/A	50	units	
Electric	al Char	acteristics T _c = 2	25°C unless oth	erwise noted.						
Symbol		Parameter		Conditions		Min.	Тур.	Max.	Unit	
Off Charac	teristics							•	•	
BV _{DSS}	Drain-Sou	rce Breakdown Voltage	V _{GS} = 0	V, $I_D = 250 \ \mu A$, $T_J =$	25°C	250			V	
ΔBV_{DSS} / ΔT_{J}	Breakdow Coefficien	n Voltage Temperature t	I _D = 250	μA, Referenced to 2	5°C		0.25		V/°C	
I _{DSS}	Zero Gate	Voltage Drain Current		50 V, V _{GS} = 0 V 00 V, T _C = 125°C				1 10	μΑ μΑ	
I _{GSSF}	Gate-Body	y Leakage Current, Forw	ard V _{GS} = 3	0 V, V _{DS} = 0 V				100	nA	
I _{GSSR}	Gate-Body	y Leakage Current, Reve	erse V _{GS} = -3	30 V, V _{DS} = 0 V				-100	nA	
On Charac	teristics									
V _{GS(th)}	Gate Thre	shold Voltage	V _{DS} = V	_{GS} , I _D = 250 μA		3.0		5.0	V	
R _{DS(on)}	Static Drai On-Resist		V _{GS} = 1	0 V, I _D = 22 A			0.058	0.069	Ω	
9 _{FS}	Forward T	ransconductance	V _{DS} = 4	0 V, I _D = 22 A			32		S	
Dynamic C	haracteris	tics								
C _{iss}	Input Capa	acitance		5 V, V _{GS} = 0 V,			2210	2870	pF	
C _{oss}	Output Ca	pacitance	f = 1.0 N	f = 1.0 MHz			450	585	pF	
C _{rss}	Reverse T	ransfer Capacitance					60	90	pF	
Switching	Characteris	stics								
t _{d(on)}	Turn-On D	elay Time		V _{DD} = 125 V, I _D = 44 A,			53	117	ns	
t _r	Turn-On F	Rise Time	R _G = 25	$R_{\rm G} = 25 \Omega$			402	814	ns	
t _{d(off)}	Turn-Off D	elay Time					85	179	ns	
t _f	Turn-Off F	all Time		(Note 4)		/	112	234	ns	
Qg	Total Gate	Charge		$V_{DS} = 200 \text{ V}, I_D = 44 \text{ A}, V_{GS} = 10 \text{ V}$			47	61	nC	
Q _{gs}	Gate-Sour	ce Charge	V _{GS} = 1				18		nC	
Q _{gd}	Gate-Drain Charge			(Note 4)			24		nC	
Drain-Sou	rce Diode C	haracteristics and Max	kimum Ratings							
I _S	Maximum	Continuous Drain-Sourc	e Diode Forwar	d Current				44	А	
I _{SM}	Maximum	Pulsed Drain-Source Die	ode Forward Cu	irrent				176	А	
V_{SD}	Drain-Sou	rce Diode Forward Volta	ge V _{GS} = 0	V, I _S = 44 A				1.4	V	
t _{rr}	Reverse F	Recovery Time		V, I _S = 44 A,			195		ns	
Q _{rr}	Reverse F	Recovery Charge	dl _F /dt =1	dI _F /dt =100 A/μs			1.8		μC	

Notes:

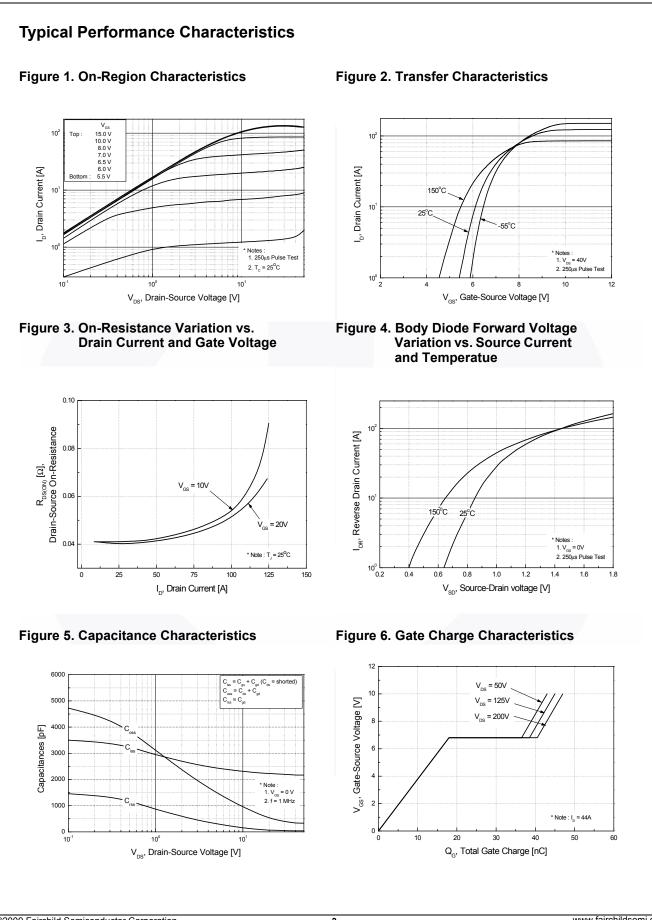
1. Repetitive rating: pulse-width limited by maximum junction temperature.

Package Marking and Ordering Information

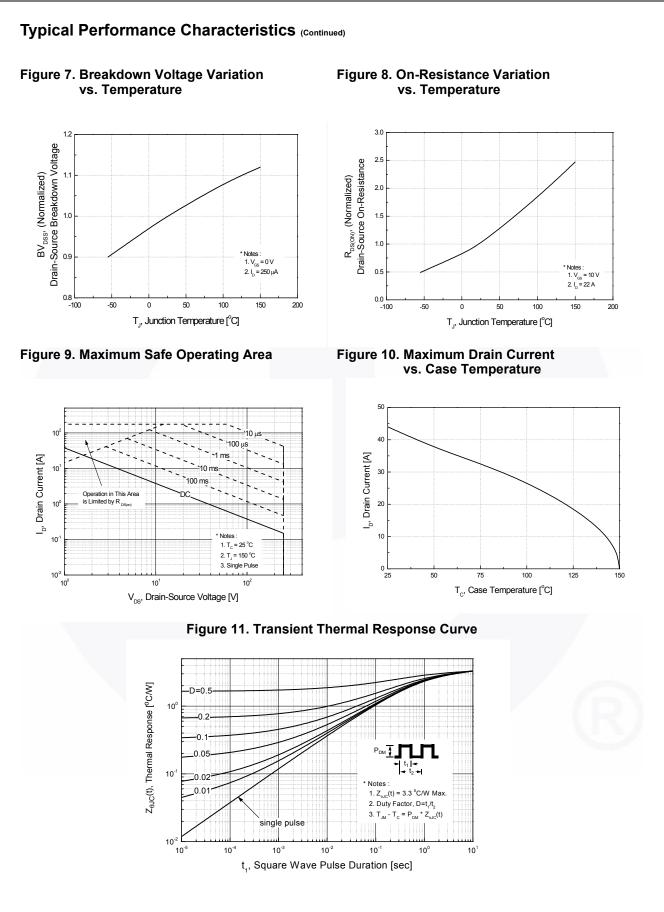
2. L = 1.7 mH, I_{AS} = 44 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C.

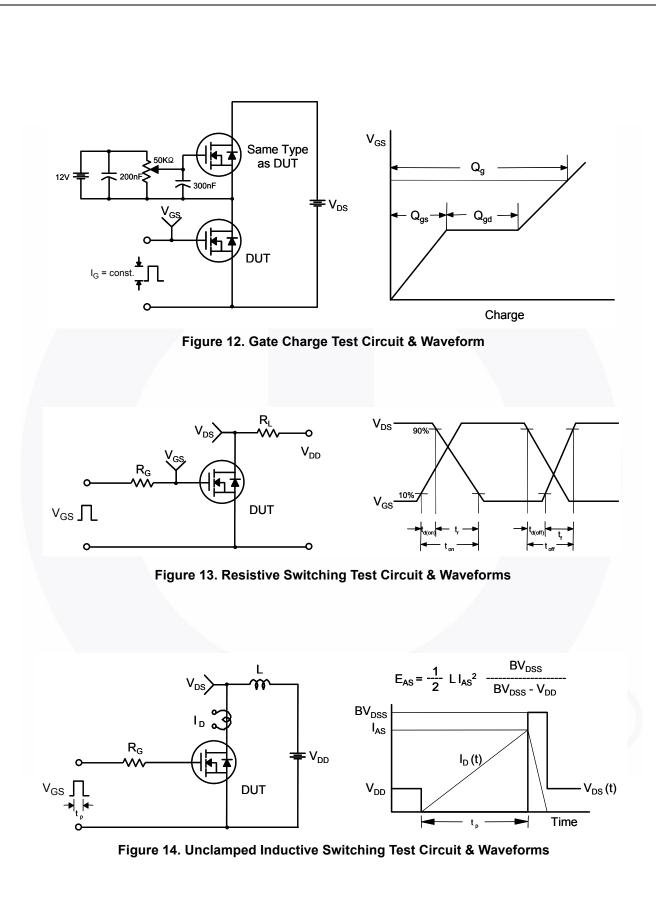
3. I_{SD} \leq 44 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

4. Essentially independent of operating temperature typical characteristics.



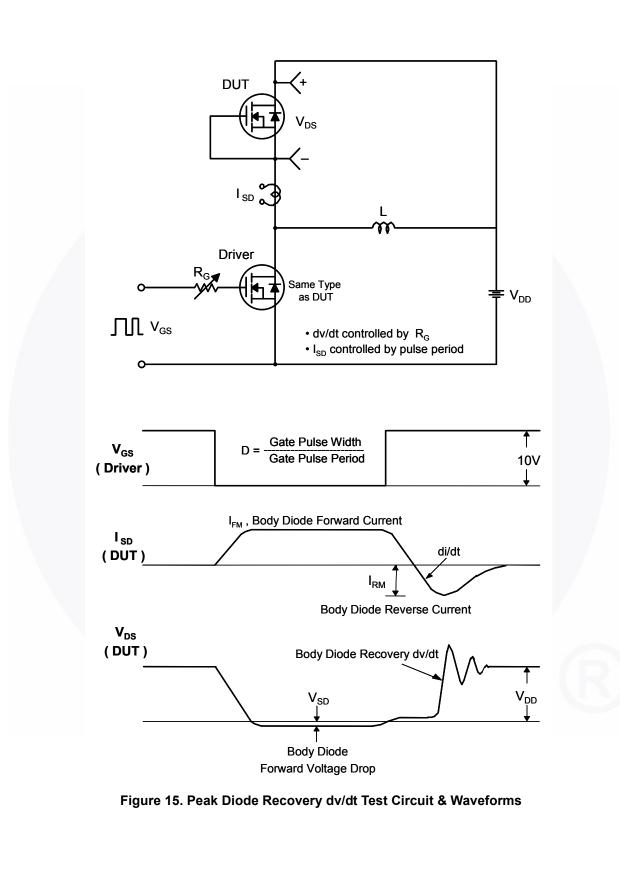
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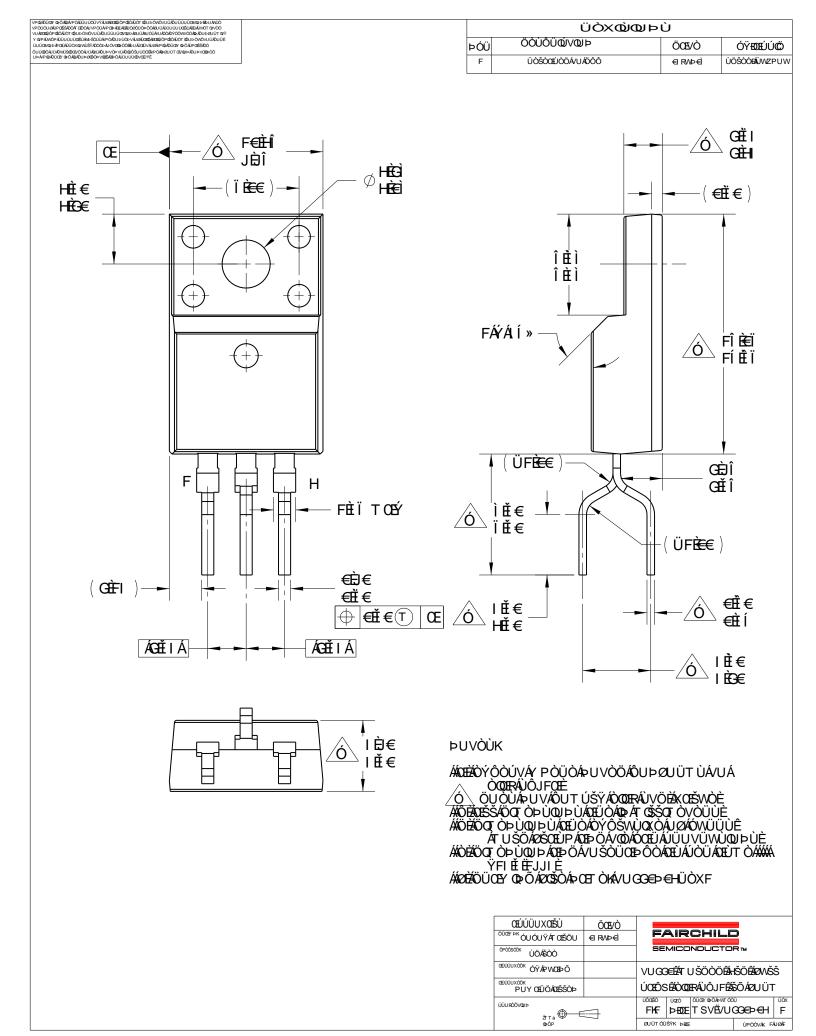


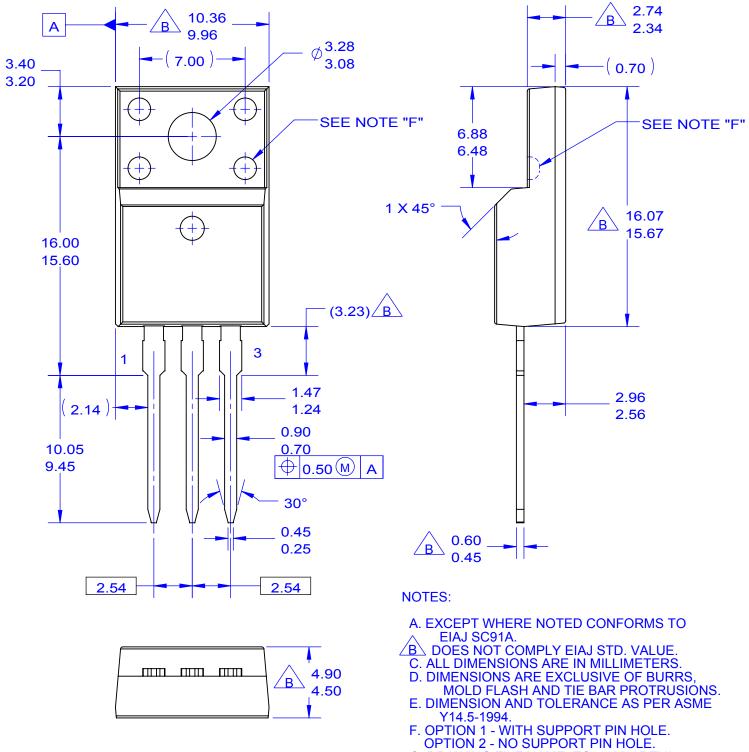


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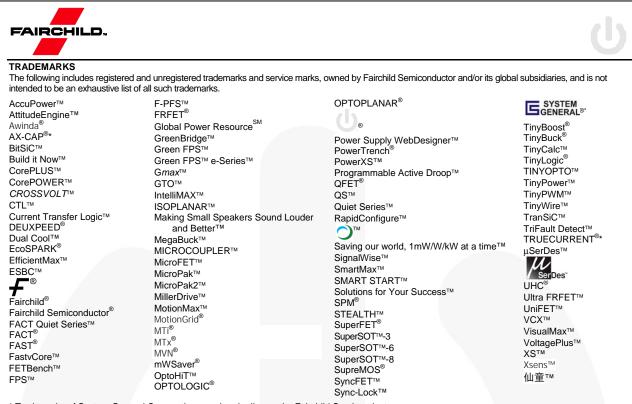
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